

#5 3-2-01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

I hereby certify that this paper Applicants: Jeun et al. is being deposited with the United States Postal Service Serial No.: 09/677,558 with sufficient postage as first class mail in an envelope Filed: September 29, 2000 addressed to: Commissioner for Patents, Washington, D.C. For: SEMICONDUCTOR POWER 20231 on this date: MODULE HAVING AN ELECTRICALLY INSULATING HEAT SINK AND METHOD OF MANUFACTURING THE December 19, 2000 SAME Attorney Docket No.: 29347/990488 Group Art Unit: 2811 Registration No. 28,491 Attorney for Applicants Examiner: Not yet assigned

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Washington, D.C. 20231

Sir:

The patent listed on the enclosed PTO Form-1449 is submitted pursuant to 37 CFR §§ 1.56, 1.97, and 1.98. A copy of the patent is enclosed.

This information disclosure statement is being filed within three months of the filing date of the application. In accordance with 37 CFR §1.97(b), no certification or fee is required.

The Commissioner is authorized to charge any fee deficiency required by this paper, or credit any overpayment, to Deposit Account No. 13-2855. A copy of this paper is enclosed.

Respectfully submitted,

MARSHALL, O'TOOLE, GERSTEIN, MURRAY & BORUN 6300 Sears Tower 233 South Wacker Drive Chicago, Illinois 60606-6402 (312) 474-6300

Bv:

James P. Zeller Reg No: 28,491

December 19, 2000